

# TLP281, TLP281-4

**PROGRAMMABLE CONTROLLERS  
AC/DC-INPUT MODULE  
PC CARD MODEM(PCMCIA)**

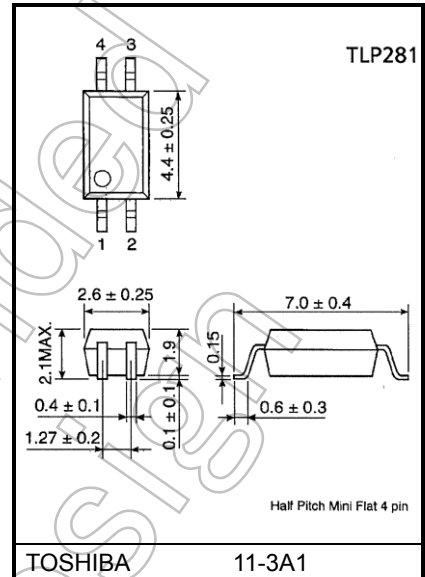
Unit: mm

TLP281 and TLP281-4 is a very small and thin coupler, suitable for surface mount assembly in applications such as PCMCIA Fax modem, programmable controllers.

TLP281 and TLP281-4 consist of photo transistor, optically coupled to an infrared emitting diode.

- Collector-Emitter Voltage : 80 V (min)
- Current Transfer Ratio : 50% (min)  
Rank GB : 100% (min)
- Isolation Voltage : 2500 Vrms (min)
- UL-recognized : UL 1577, File No.E67349
- cUL-recognized : CSA Component Acceptance Service No.5A  
File No.E67349
- VDE-approved : EN 60747-5-5 (Note 1)

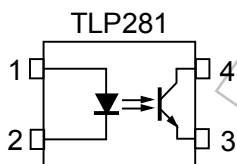
Note 1: When a VDE approved type is needed, please designate the **Option(V4)**.



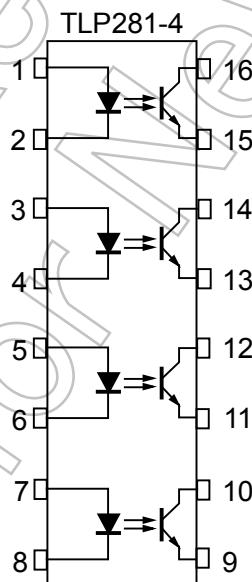
TOSHIBA 11-3A1

Weight: 0.05 g (typ.)

**Pin Configuration (top view)**

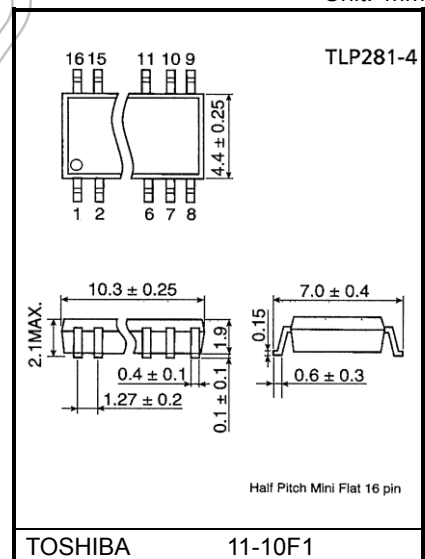


1: ANODE  
2: CATHODE  
3: EMITTER  
4: COLLECTOR



1,3,5,7 : ANODE  
2,4,6,8 : CATHODE  
9,11,13,15 : EMITTER  
10,12,14,16 : COLLECTOR

Unit: mm



TOSHIBA 11-10F1

Weight: 0.19 g (typ.)

Start of commercial production  
1996-03

## Current Transfer Ratio

TYPE	Classification (Note 1)	Current Transfer Ratio (%) ( $I_C/I_F$ )		Marking of Classification
		$I_F = 5 \text{ mA}, V_{CE} = 5 \text{ V}, T_a = 25^\circ\text{C}$		
		Min	Max	
TLP281	Blank	50	600	Blank, Y <sup>■</sup> , YE, G, G <sup>■</sup> , GR, B, BL, GB
	Rank Y	50	150	YE, Y <sup>■</sup>
	Rank GR	100	300	GR, G, G <sup>■</sup>
	Rank BL	200	600	BL, B
	Rank GB	100	600	GB, GR, G, G <sup>■</sup> , BL, B
	Rank YH	75	150	Y <sup>■</sup>
	Rank GRL	100	200	G
	Rank GRH	150	300	G
TLP281-4	Blank	50	600	Blank, GB
	Rank GB	100	600	GB

Note 1: Ex. rank GB: TLP281 (GB)

Note: Application type name for certification test, please use standard product type name, i.e.

TLP281 (GB): TLP281, TLP281-4 (GB): TLP281-4

Not Recommended for New Design

### Absolute Maximum Ratings (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING		UNIT
			TLP281	TLP281-4	
LED	Forward Current	IF	50		mA
	Forward Current Derating	$\Delta I_F/^\circ\text{C}$	-0.7 (Ta $\geq$ 53°C)	-0.5 (Ta $\geq$ 25°C)	mA/°C
	Pulse Forward Current (100 $\mu$ s pulse, 100 pps)	IFP	1		A
	Reverse Voltage	VR	5		V
	Diode power dissipation	PD	100	70	mW
	Diode power dissipation derating	$\Delta P_D/^\circ\text{C}$	-1.39 (Ta $\geq$ 53°C)	-0.7 (Ta $\geq$ 25°C)	mW/°C
	Junction Temperature	Tj	125		°C
DETECTOR	Collector-Emitter Voltage	VCEO	80		V
	Emitter-Collector Voltage	VECO	7		V
	Collector Current	IC	50		mA
	Collector Power Dissipation (1 Circuit)	PC	150	100	mW
	Collector Power Dissipation Derating (Ta $\geq$ 25°C) (1 Circuit)	$\Delta P_C/^\circ\text{C}$	-1.5	-1.0	mW/°C
	Junction Temperature	Tj	125		°C
Operating Temperature Range	Topr	-55 to 100		°C	
Storage Temperature Range	Tstg	-55 to 125		°C	
Lead Soldering Temperature (10 s)	Tsol	260		°C	
Total Package Power Dissipation (1 Circuit)	PT	200	170	mW	
Total Package Power Dissipation Derating (Ta $\geq$ 25°C) (1 Circuit)	$\Delta P_T/^\circ\text{C}$	-2.0	-1.7	mW/°C	
Isolation Voltage (AC, 60 s, R.H. $\leq$ 60 %) (Note 1)	BVs	2500		Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two terminal device : LED side pins shorted together and DETECTOR side pins shorted together.

### Electrical Characteristics (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
LED	Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
	Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 5 V	—	—	10	μA
	Capacitance	C <sub>T</sub>	V = 0 V, f = 1 MHz	—	30	—	pF
DETECTOR	Collector-Emitter Breakdown Voltage	V <sub>(BR)</sub> CEO	I <sub>C</sub> = 0.5 mA	80	—	—	V
	Emitter-Collector Breakdown Voltage	V <sub>(BR)</sub> ECO	I <sub>E</sub> = 0.1 mA	7	—	—	V
	Collector Dark Current (Note 1)	I <sub>CEO</sub>	V <sub>CE</sub> = 48 V	—	0.01	0.1	μA
			Ambient Light Below (100 lx) (Note 2)	—	2	10	
			V <sub>CE</sub> = 48 V, Ta = 85 °C	—	2	50	μA
Ambient Light Below (100 lx) (Note 2)	—	4	50				
Capacitance (Collector to Emitter)	C <sub>CE</sub>	V = 0 V, f = 1 MHz	—	10	—	pF	

Note 1: Because of the construction, leak current might be increased by ambient light. Please use photocoupler with less ambient light.

Note 2: Irradiation to marking side using standard light bulb.

### Coupled Electrical Characteristics (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Current Transfer Ratio	I <sub>C</sub> /I <sub>F</sub>	I <sub>F</sub> = 5 mA, V <sub>CE</sub> = 5 V	50	—	600	%
		Rank GB	100	—	600	
Saturated CTR	I <sub>C</sub> /I <sub>F</sub> (sat)	I <sub>F</sub> = 1 mA, V <sub>CE</sub> = 0.4 V	—	60	—	%
		Rank GB	30	—	—	
Collector-Emitter Saturation Voltage	V <sub>CE</sub> (sat)	I <sub>C</sub> = 2.4 mA, I <sub>F</sub> = 8 mA	—	—	0.4	V
		I <sub>C</sub> = 0.2 mA, I <sub>F</sub> = 1 mA	—	0.2	—	
		Rank GB	—	—	0.4	
Off-State Collector Current	I <sub>C</sub> (off)	V <sub>F</sub> = 0.7 V, V <sub>CE</sub> = 48 V	—	—	10	μA

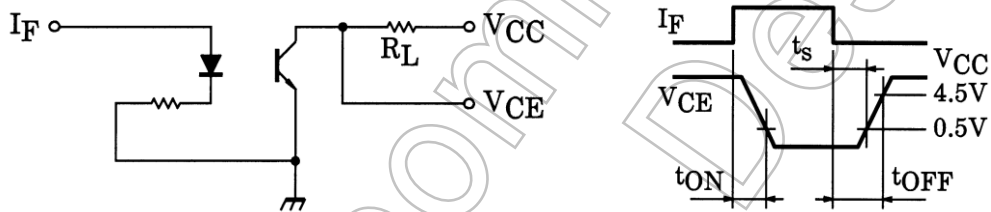
## Isolation Characteristics (Ta = 25°C)

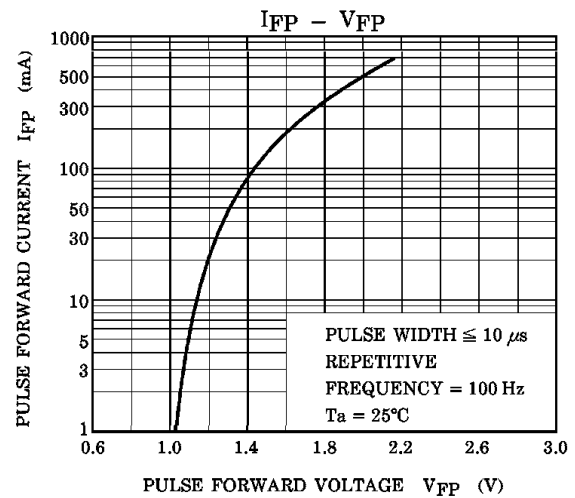
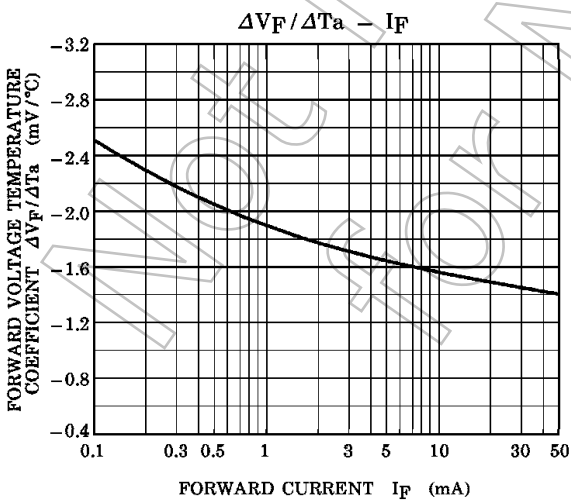
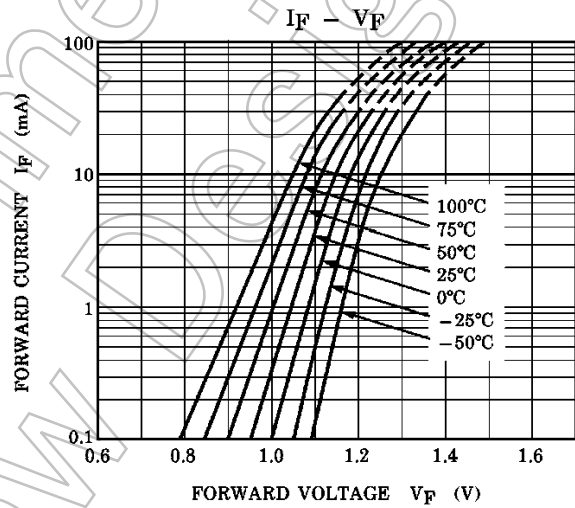
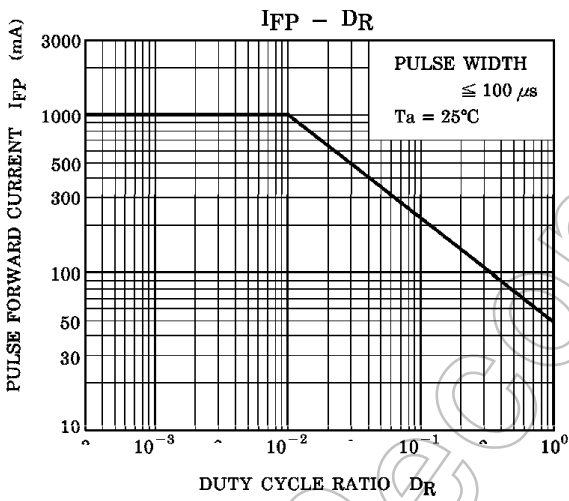
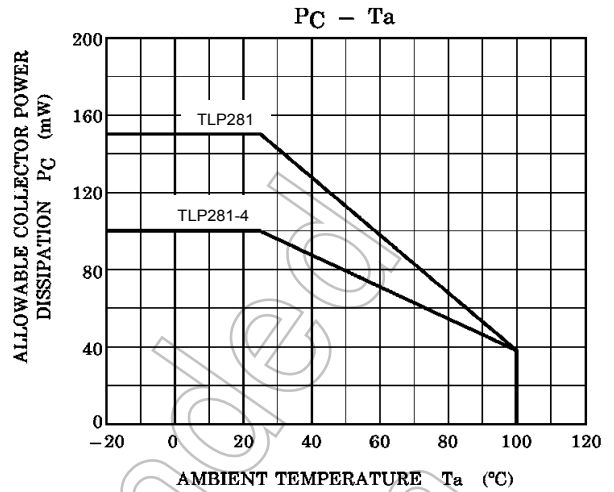
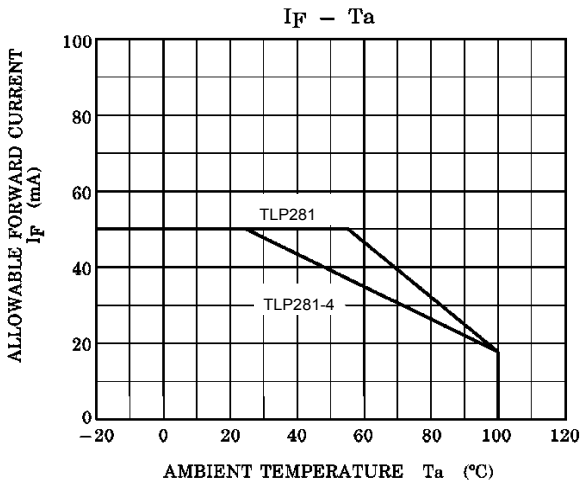
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Capacitance (Input to Output)	Cs	V <sub>S</sub> = 0 V, f = 1 MHz	—	0.8	—	pF
Isolation Resistance	R <sub>S</sub>	V <sub>S</sub> = 500 V, R.H. ≤ 60 %	5×10 <sup>10</sup>	10 <sup>14</sup>	—	Ω
Isolation Voltage	BV <sub>S</sub>	AC, 60 s	2500	—	—	Vrms

## Switching Characteristics (Ta = 25°C)

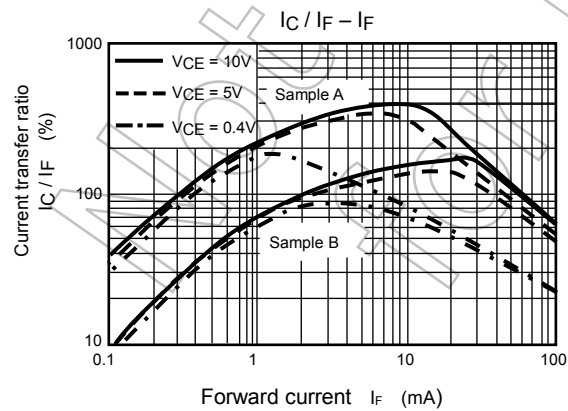
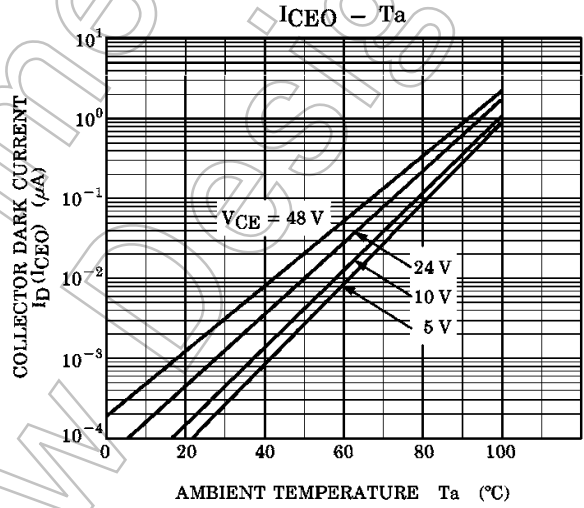
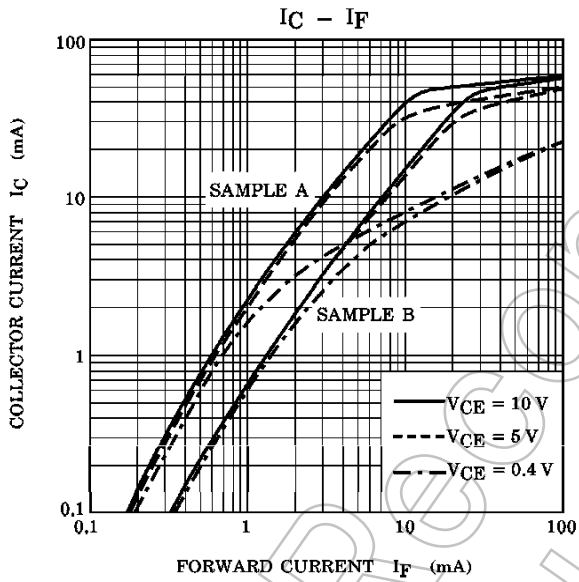
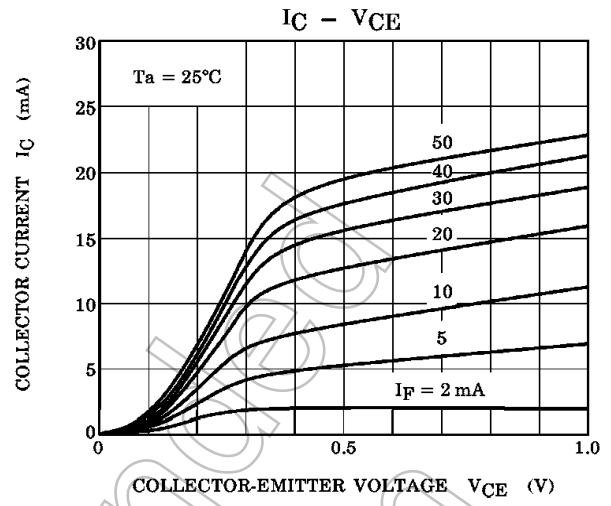
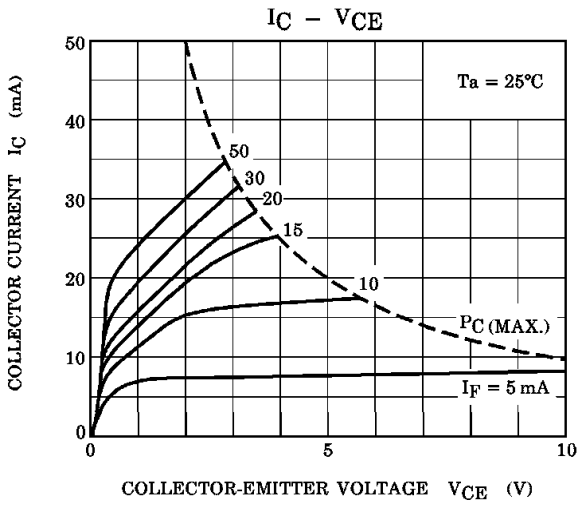
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Rise Time	t <sub>r</sub>	V <sub>CC</sub> = 10 V, I <sub>C</sub> = 2 mA R <sub>L</sub> = 100 Ω	—	2	—	μs
Fall Time	t <sub>f</sub>		—	3	—	
Turn-On Time	t <sub>on</sub>		—	3	—	
Turn-Off Time	t <sub>off</sub>		—	3	—	
Turn-On Time	t <sub>ON</sub>	R <sub>L</sub> = 1.9 kΩ (Fig.1) V <sub>CC</sub> = 5 V, I <sub>F</sub> = 16 mA	—	2	—	μs
Storage Time	t <sub>s</sub>		—	25	—	
Turn-Off Time	t <sub>OFF</sub>		—	40	—	

Fig.1: SWITCHING TIME TEST CIRCUIT

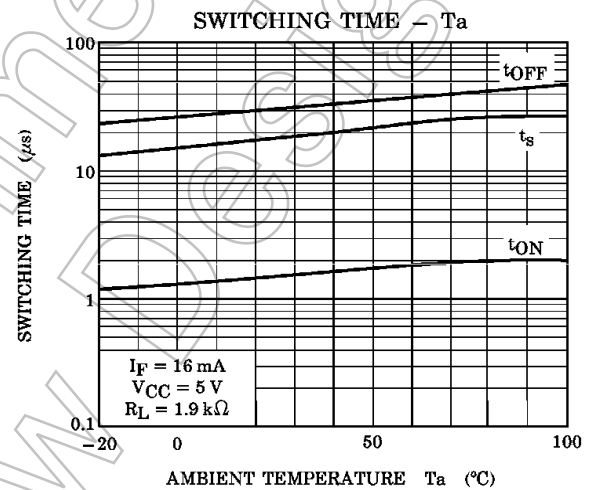
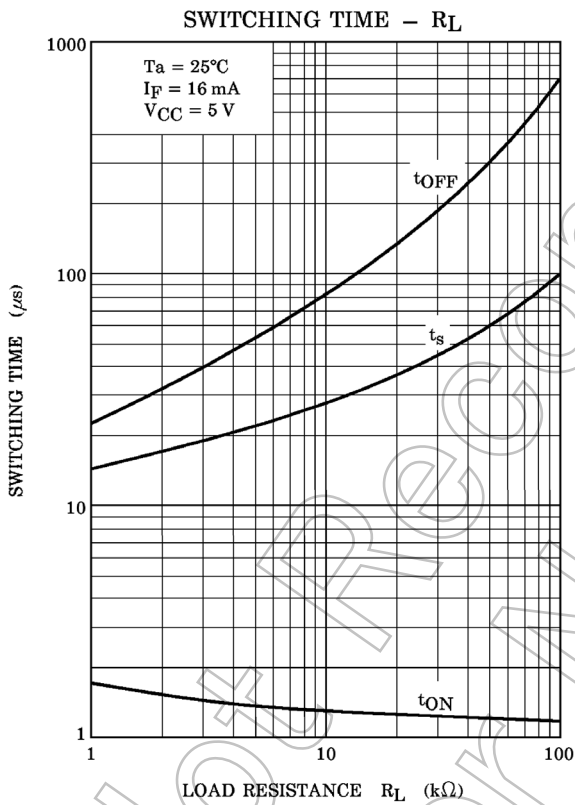
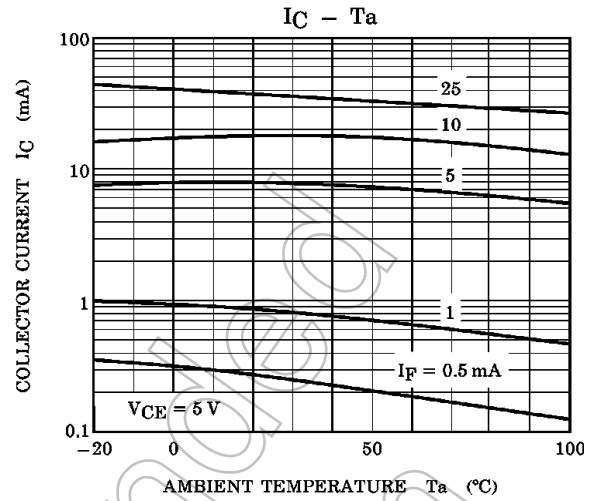
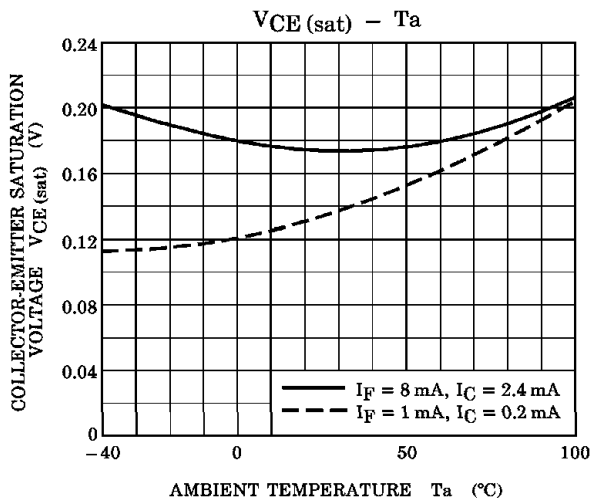




NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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